FORM PTO-1595 (Rev. 10/02) OMD No. 0651-0011 (exp. 6/30/2005)	J.S. DEPARTMENT OF COMMERC Patent and Trademark Office 02917265
	Please record the attached original documents or copy thereof.
Name of conveying party(ies):     Ihl-Ho LEE	2. Name and address of receiving party(ies):  Name: Hynix Semiconductor, Inc.
Additional name(s) of conveying party(ies) attached  No Yes  No Yes  No Yes  Assignment Merger Security Agreement Change of Name Other  Execution Date: 11/21/04	Street Address: San 136-1, Ami-ri, Bubalj-eub,  Ichon-shi  City: Kyoungki-do State: ZIP: 467-8  Country: Republic of Korea
ZACOMICII Daio.	Additional name(s)& address(es) attached?   ☑ No ☐ Yes
Application number(s) or patent number(s):     If this document is being filed together with a ne     A. Patent Application No.(s)	B. Patent No.(s)
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Name and address of party to whom corresponder concerning document should be mailed:	6. Total number of applications and patents involved: 1
Name: Blakely, Sokoloff, Taylor & Zafman LLP  Internal Address:  Street Address: 12400 Wilshire Boulevard	7. Total Fee (37 CFR 3.41)\$ 40.00  ■ Enclosed □ Authorized to be charged to deposit account
7th Floor  City: Los Angeles State: CA ZIP:	8. Deposit Account Number:  90025  02-2666  (Attach duplicate copy of this page if paying by deposit account)
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9. Statement and signature.  To the best of my knowledge and belief, the foregoing is true  55 6TUH11 00000032 11022119  40.00 6P	e and correct and any attached copy is a true copy of the original document.
Eric S. Hyman	a relising

Mail documents to be recorded with required cover sheet information to: Mail Stop Assignment Recordation Services Director of the US Patent and Trademark Office P.O. Box 1450

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Signature

Alexandria, VA 22313-1450

Docket No. 51876P764

Name of Person Signing

**PATENT REEL: 016130 FRAME: 0812** 

Date

## **ASSIGNMENT**

In consideration of good and valuable consideration, the receipt of which is hereby acknowledged, the undersigned,

LEE, Ihl-Ho

Hereby sells, assigns, and transfers to:

Hynix Semiconductor, Inc.

a corporation of Republic of Korea, having a principal place of business at:

San 136-1, Ami-ri, Bubal-eub, Ichon-shi, Kyoungki-do 467-860, Republic of Korea ("Assignee"), and its successors, assigns and legal representatives, the entire right, title and interest for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent,

[x_] which has been	executed by the undersigned concurrently herewith,
[] which was filed	and assigned Serial No,
and is entitled:	
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and in and to said application and all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be issued in the United States and all foreign countries on said improvements; and in and to all rights of priority resulting from the filing of said United States application;

Agree that said Assignee may apply for and receive Letters Patent for said improvements in its own name; and that, when requested, without charge to, but at the expense of, said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this Assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and representatives, all facts known to the undersigned relating to said improvements and the history thereof; and generally do everything possible which said Assignee, its successors, assigns or representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns and legal representatives; and

Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

Date: <u>μ β</u> , 200 μ	_, 200 <i>u</i>	Lee ; blo bro	<u>,</u>
	Name: LEE, Ihl-Ho		

PATENT REEL: 016130 FRAME: 0813